

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Benny H. Johnson

Application No.: 10/555,899

Confirmation No.: 4474

Filed: May 7, 2004

Art Unit: 2841

For: MICROELECTRONIC SUBSTRATES WITH
THERMALLY CONDUCTIVE PATHWAYS
AND METHODS OF MAKING SAME

Examiner: X. Chen

AMENDMENT IN RESPONSE TO NON-FINAL OFFICE ACTION

MS Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

INTRODUCTORY COMMENTS

In response to the Office Action dated September 22, 2009, please amend the above-identified U.S. patent application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 4 of this paper.